

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)					
PCN #: <b>A0706-03</b>	DATE: <b>6/30/2007</b>	MEANS OF DISTINGUISHING CHANGED DEVICES:			
Product Affected: CVBGA-100 (Gregory (See attached affe		☐ Product Mark ■ Back Mark Lot # will have a "W" prefix ☐ Date Code ☐ Other			
Date Effective: 9/30/2007		□ Other			
Contact: Geoffrey Cortes  Title: Product Quality Assurance  Phone #: (408) 284-8321  Fax #: (408) 284-1450		Attachment: Yes No  Samples: Please contact your local sales representative for sample request & availability.			
E-mail: Geoffrey.Cortes@idt.com	CHANCE.	sample request & availability.			
ESCRIPTION AND PURPOSE OF CHANGE:    Die Technology					
RELIABILITY/QUALIFICATION S	SUMMARY:				
Refer to qualification data shown in atta	achment I.				
CUSTOMER ACKNOWLEDGMEN	T OF RECEIPT:				
to grant approval or request additional it will be assumed that this change is ac	information. If IDT does no exceptable.  rsion manufactured after the	change. Please use the acknowledgement below or E-Mail not receive acknowledgement within 30 days of this notice he process change effective date until the inventory			
Customer:		Approval for shipments prior to effective date.			
Name/Date:	E-1	Mail Address:			
Title:	Ph	one# /Fax# :			
CUSTOMER COMMENTS:					
IDT ACKNOWLEDGMENT OF RE	CEIPT:				
RECD. BY:		DATE:			

IDT FRA-1509-01 REV. 00 09/18/01

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Refer To QCA-1795



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## PRODUCT/PROCESS CHANGE NOTICE (PCN)

#### **ATTACHMENT I - PCN # : A0706-03**

**PCN Type:** Manufacturing Site - Alternate Assembly Location

**Data Sheet Change:** None

No change in moisture sensitivity level (MSL)

#### **Detail Of Change:**

This notification is to advise our customers that IDT is adding AIT-Indonesia as an alternate assembly facility for CVBGA-100 standard and green plastic packages using the assembly material set as listed in the tables under each group.

There is no change in the moisture sensitivity level (MSL).

#### Sample Availability:

Samples for each package type are available for customer evaluation, but may not be available for all devices.

Please contact your local IDT sales representative for your sample request and availability.



# PRODUCT/PROCESS CHANGE NOTICE (PCN)

## ATTACHMENT I - PCN #: A0706-03

## **Qualification Information and Qualification Data:**

**Affected Packages:** CVBGA-100 (BY/BYG100 packages)

**Assembly Material:** See Table below

Description	Existing	Add	
Assembly Location	AMKOR-Philippines	AIT-Indonesia	
Assembly Material	Die Attach: Ablestik 2300	2000B	
	Wire: HP 1.0 mil	1.0 mil	
	Mold Compound: EME-G770	EME-G760	
	Substrate: BT	ВТ	
	Solder Balls: Sn/Pb (standard) and Sn/Ag/Cu (green)	Sn/Pb (standard) and Sn/Ag/Cu (green)	

## **Qualification Test Results:**

**Test Vehicle:** CVBGA-144 (1 lot)

Test Description	Test Method	Test Results (SS/Rej)
* Temperature Cycling (Cond B, 1000 cycles)	JESD22-A104B	45/0
* HAST (130°C/85% RH, 100 hours)	JESD22-A110B	45/0
High Temperature Stabilization Bake (150 °C, 1000 hours)	JESD22-A103B	77/0

**Notes:** \* Test requires moisture pre-conditioning sequence per JESD22-A113C.

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# PRODUCT/PROCESS CHANGE NOTICE (PCN)

# ATTACHMENT II - PCN #: A0706-03

#### **Affected Part Number**

Part Number	Part Number	Part Number	Part Number
IDT70P247L55BYGI	IDT70P248L55BYGI	IDT70P257L55BYGI	IDT70P258L55BYGI
IDT70P247L55BYI	IDT70P248L55BYI	IDT70P257L55BYI	IDT70P258L55BYI
IDT70P9268L50BYGI			

Notes: For T & R (shipping method) suffix "8" is added to the IDT part#